

## APPROVAL SHEET

MODEL NO.:	mSMD035-60V	

CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

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Submitted by:	Chen
Approved by:	YC Lin
DATE:	26-Oct-23

SEA & LAND ELECTRONIC CORP.

#### a 375 a 300 110 030 010

## Features Surface Mount Devices

- Lead free device
- Size 4.5\*3.2 mm/0.18\*0.12 inch
- Size 4.5"3.2 mm/0.18"0.12
- for automated assembly

Computer mother board, Modem. USB hub PDAs & Charger, Analog & digital line card

Almost anywhere there is a low voltage

power supply, up to 60V and a load to be

Applications

protected, including:

■ Digital cameras, Disk drivers, CD-ROMs,

Alpha-Top (Sea & Land Alliance)

## *mSMD035-60V*

Performance Specific	ation					Maxir	mum	Resis	stance		
Model	V <sub>max</sub>	I max	hold	I <sub>trip</sub>	$\mathbf{P}_{d}$	Time To Trip				Agency Approval	
			@25°C	@25°C	Тур.	Current	Time	Ri <sub>min</sub>	R1 <sub>max</sub>	UL	TUV
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	01	101
mSMD035-60V	30	100	0.35	0.70	0.8	8.0	0.10	0.230	2.800		
Ihold = Hold Current.	Maximum cur	rent device w	vill not trip in 2	5°C still air.							
Itrip = Trip Current. M	/inimum curre	ent at which th	ne device will a	always trip in 2	25°C still air.						
Vmax = Maximum ope	rating voltage	e device can v	vithstand with	out damage a	t rated curre	nt (Imax).					
Imax = Maximum fau	It current devi	ice can withst	and without d	amage at rate	d voltage (V	max).					
Pd = Power dissipat	ion when dev	ice is in the tr	ipped state in	25°C still air e	environment	at rated voltag	e.				
Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.											
R1 <sub>max</sub> = Maximum device resistance is measured one hour post reflow.											
CAUTION : Operation	beyond the sp	ecified rating	s may result i	n damage and	l possible ar	cing and flame					

#### **Environmental Specifications**

Test	Conditions					
Passive aging	+85°C, 1000 hrs.					
Humidity aging	+85°C, 85% R.H. , 168 hours					
Thermal shock	+85°C to -40°C, 20 times					
Resistance to solvent	MIL-STD-202, Method 215					
Vibration	MIL-STD-202, Method 201					
Ambient operating conditions : - 40 °C to +85 °C						
Maximum surface temperature of the device in the tripped state is 125 °C						
In case of special use, please contact our engineer						

#### Agency Approvals :

#### Regulation/Standard:

2015/863/EU

HF

PhoRoHS

EN14582

#### Ihold Versus Temperature

Model	Maximum an	nbient operatii	ng temperatui	re (T <sub>mao</sub> ) vs. h	old current (I	nold)			
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
mSMD035-60V	0.51	0.45	0.40	0.35	0.30	0.26	0.24	0.21	0.17

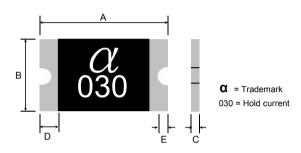


### mSMD035-60V

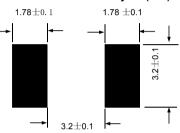
Alpha-Top (Sea & Land Alliance)

Construction And Dir	mension (Unit:	mm)						
Model		4		3	0	;	D	E
Widdei	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
mSMD035-60V	4.37	4.73	3.07	3.41	0.50	1.00	0.30	0.25

#### **Dimensions & Marking**



#### **Recommended Pad Layout (mm)**



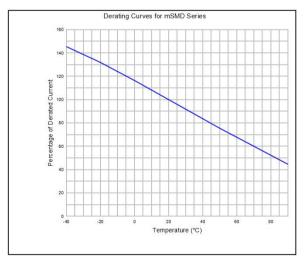
#### **Termination Pad Characteristics**

Terminal pad materials : Terminal pad solderability : Rework

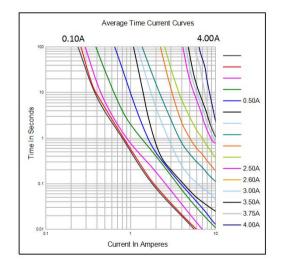
Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Use standard industry practices, the removal device must be replaced with a fresh one.

#### **Thermal Derating Curve**



#### Typical Time-To-Trip At 25°C



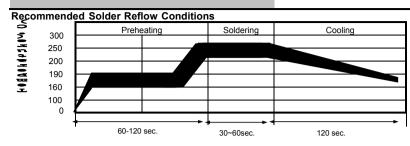
## WARNING:

- · Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame. · PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components. Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.

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### mSMD035-60V

#### Alpha-Top (Sea & Land Alliance)



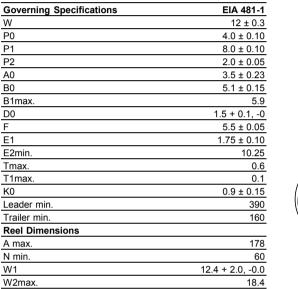
• Recommended reflow methods : IR, vapor phase oven, hot air oven. · Devices are not designed to be wave soldered to the bottom side of the board.

Recommended maximum paste thickness is 0.25 mm (0.010 inch). Devices can be cleaned using standard method and solvents.

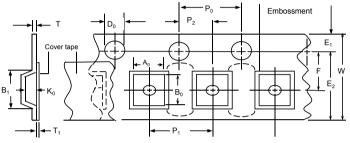
Note : If reflow temperatures exceed the recommended profile. devices may not meet the performance requirements.

Tape And Reel Specifications (mm)

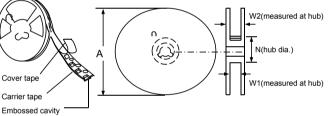
EIA Ta	pe Comp	onent D	imension
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#### **EIA Reel Dimensions**



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#### Storage And Handling

• Storage conditions : 40°C max, 70% R.H.

· Devices may not meet specified performance

if storage conditions are exceeded.

### Oudou Information

Order Information	Packaging			
mSMD	035	Tape & Reel Quantity		
Product name	Hold			
Size 4532mm/1812 inch	Current	1,500 pcs/reel		
SMD : surface mount device	0.35A			

Tape & reel packaging per EIA481-1

#### Labeling Information

